BLF6G13L-250P; BLF6G13LS-250P(G)

Power LDMOS transistor

AMPLEON

Rev. 5. — 1 September 2015 **Product data sheet**

1. Product profile

1.1 General description

250 W LDMOS power transistor intended for CW applications at a frequency of 1.3 GHz.

Table 1. Test information

Typical RF performance at T_{case} = 25 °C; I_{Dq} = 100 mA; in a class-AB production test circuit.

Test signal	f	V_{DS}	$P_{L(1dB)}$	G_p	η_D
	(GHz)	(V)	(W)	(dB)	(%)
CW	1.3	50	250	17	56

1.2 Features and benefits

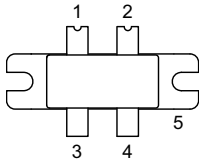
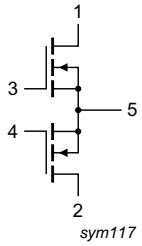
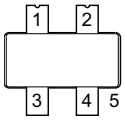
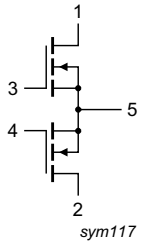
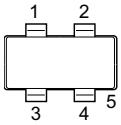
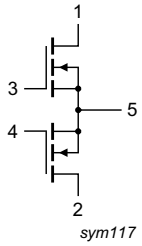
- Easy power control
- Integrated ESD protection
- Excellent ruggedness
- High efficiency
- Excellent thermal stability
- Internally matched for ease of use
- Compliant to Directive 2002/95/EC, regarding Restriction of Hazardous Substances (RoHS)

1.3 Applications

- Industrial, scientific and medical applications

2. Pinning information

Table 2. Pinning

Pin	Description	Simplified outline	Graphic symbol
BLF6G13L-250P (SOT1121A)			
1	drain1		
2	drain2		
3	gate1		
4	gate2		
5	source [1]		
BLF6G13LS-250P (SOT1121B)			
1	drain1		
2	drain2		
3	gate1		
4	gate2		
5	source [1]		
BLF6G13LS-250PG (SOT1121E)			
1	drain1		
2	drain2		
3	gate1		
4	gate2		
5	source [1]		

[1] Connected to flange.

3. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
BLF6G13L-250P	-	flanged LDMOST ceramic package; 2 mounting holes; 4 leads	SOT1121A
BLF6G13LS-250P	-	earless flanged LDMOST ceramic package; 4 leads	SOT1121B
BLF6G13LS-250PG	-	earless flanged LDMOST ceramic package; 4 leads	SOT1121E

4. Limiting values

Table 4. Limiting values
In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Min	Max	Unit
V_{DS}	drain-source voltage	-	100	V
V_{GS}	gate-source voltage	−0.5	+13	V
T_{stg}	storage temperature	−65	+150	°C
T_j	junction temperature [1]	-	225	°C

[1] Continuous use at maximum temperature will affect the reliability, for details refer to the on-line MTF calculator.

5. Thermal characteristics

Table 5. Thermal characteristics

Symbol	Parameter	Conditions	Typ	Unit
$R_{th(j-c)}$	thermal resistance from junction to case	T_{case} = 85 °C; P_L = 250 W	0.26	K/W

6. Characteristics

Table 6. DC characteristics
T_j = 25 °C; per section unless otherwise specified.

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$V_{(BR)DSS}$	drain-source breakdown voltage	V_{GS} = 0 V; I_D = 1.4 mA	100	-	-	V
$V_{GS(th)}$	gate-source threshold voltage	V_{DS} = 10 V; I_D = 235 mA	1.4	1.8	2.4	V
I_{DSS}	drain leakage current	V_{GS} = 0 V; V_{DS} = 50 V	-	-	1.4	μA
I_{DSX}	drain cut-off current	V_{GS} = $V_{GS(th)}$ + 3.75 V; V_{DS} = 10 V	-	21	-	A
I_{GSS}	gate leakage current	V_{GS} = 11 V; V_{DS} = 0 V	-	-	240	nA
g_{fs}	forward transconductance	V_{DS} = 10 V; I_D = 120 mA	-	1	-	S
$R_{DS(on)}$	drain-source on-state resistance	V_{GS} = $V_{GS(th)}$ + 3.75 V; I_D = 4.75 A	-	200	-	mΩ

Table 7. RF characteristics
Test signal: CW; f = 1.3 GHz; RF performance at V_{DS} = 50 V; I_{Dq} = 100 mA; T_{case} = 25 °C; unless otherwise specified, in a class-AB production test circuit.

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
V_{DS}	drain-source voltage	P_L = 250 W	-	-	50	V
G_p	power gain	P_L = 250 W	15	17	-	dB
RL_{in}	input return loss	P_L = 250 W	-	−30	−20	dB
η_D	drain efficiency	P_L = 250 W	52	56	-	%

7. Application information

7.1 Ruggedness in class-AB operation

The BLF6G13L-250P, BLF6G13LS-250P and BLF6G13LS-250PG are capable of withstanding a load mismatch corresponding to VSWR = 5 : 1 through all phases under the following conditions: V_{DS} = 50 V; I_{Dq} = 100 mA; P_L = 250 W; f = 1.3 GHz.

7.2 Impedance information

Table 8. Typical impedance

Typical values valid per section unless otherwise specified.

f	Z_S	Z_L optimized for G_p	Z_L optimized for η_D
(MHz)	(Ω)	(Ω)	(Ω)
1200	3.03 – j8.15	2.03 – j0.25	1.46 – j0.47
1300	4.06 – j9.52	1.67 – j0.92	1.19 – j0.95
1400	7.00 – j9.61	1.50 – j1.48	1.22 – j1.49

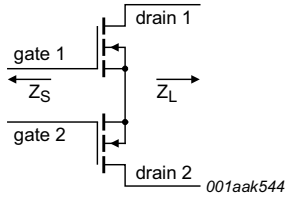


Fig 1. Definition of transistor impedance

7.3 Circuit information

Table 9. List of components

For application circuit see Figure 2.

Component	Description	Value	Remarks
C1, C2	multilayer ceramic chip capacitor	1.9 pF [1]	
C3, C4	multilayer ceramic chip capacitor	4.7 pF [1]	
C5	multilayer ceramic chip capacitor	10 pF [1]	
C6, C7, C8, C9, C10, C11, C38, C39	multilayer ceramic chip capacitor	56 pF [1]	
C12, C13	multilayer ceramic chip capacitor	100 pF [2]	
C14, C15, C32, C34	multilayer ceramic chip capacitor	1 nF [2]	
C16, C17	electrolytic capacitor	10 μF, 50 V	220 X5R
C20, C21, C22, C23	multilayer ceramic chip capacitor	3.0 pF [1]	
C40, C41	multilayer ceramic chip capacitor	2.4 pF [1]	
C42, C43, C44, C45	multilayer ceramic chip capacitor	2.7 pF [1]	
C24	multilayer ceramic chip capacitor	0.8 pF [1]	
C25	multilayer ceramic chip capacitor	0.6 pF [1]	

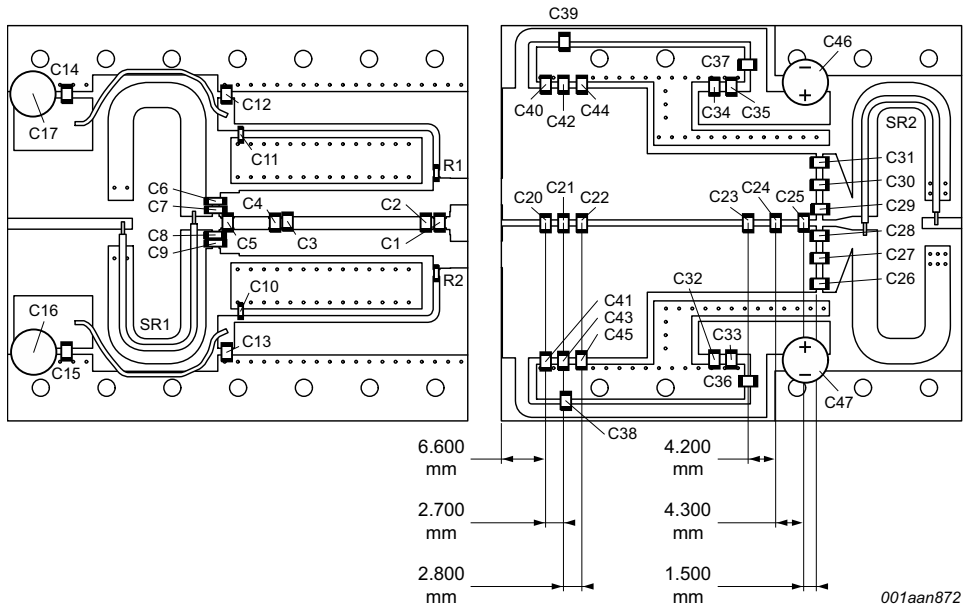
Table 9. List of components *…continued*
For application circuit see Figure 2.

Component	Description	Value	Remarks
C26, C27, c28, C29, C30, C31, C33, C35	multilayer ceramic chip capacitor	100 pF [1]	
C36, C37	multilayer ceramic chip capacitor	20 nF [3]	
C46, C47	electrolytic capacitor	100 μF, 63 V	
R1, R2	SMD resistor 0603	5.1 Ω	
SR1	COAX	25 Ω	UT-141C-25-TP
SR2	COAX	35 Ω	UT-141C-35-TP

[1] American Technical Ceramics type 800B or capacitor of same quality.

[2] American Technical Ceramics type 100B or capacitor of same quality.

[3] American Technical Ceramics type 200B or capacitor of same quality.



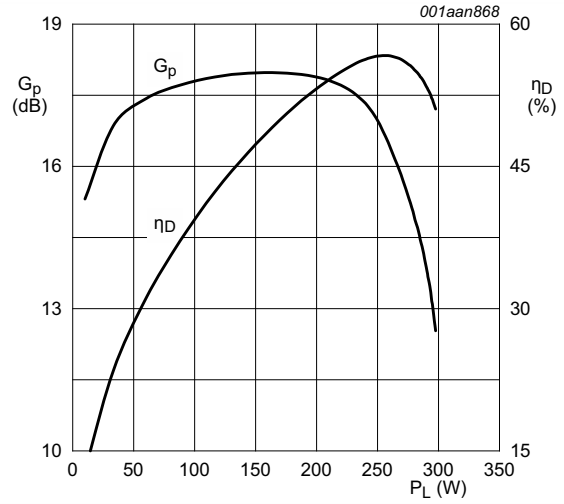
Printed-Circuit Board (PCB): Duroid 4350B; ε_r = 3.48; thickness = 0.762 mm; thickness copper plating = 35 μm.

See Table 9 for a list of components.

Fig 2. Component layout for application circuit

7.4 Graphical data

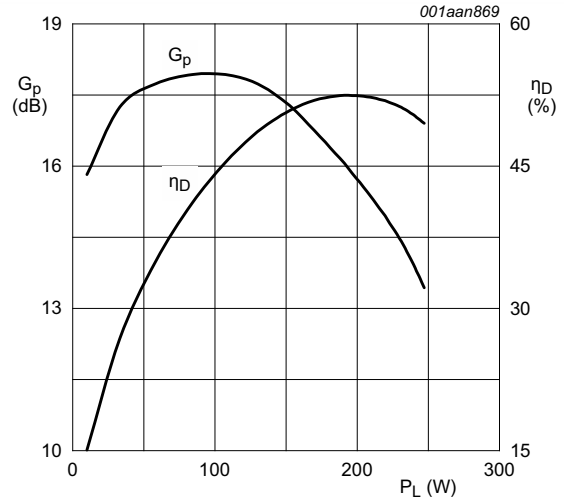
7.4.1 CW



V_{DS} = 50 V; I_{Dq} = 100 mA.

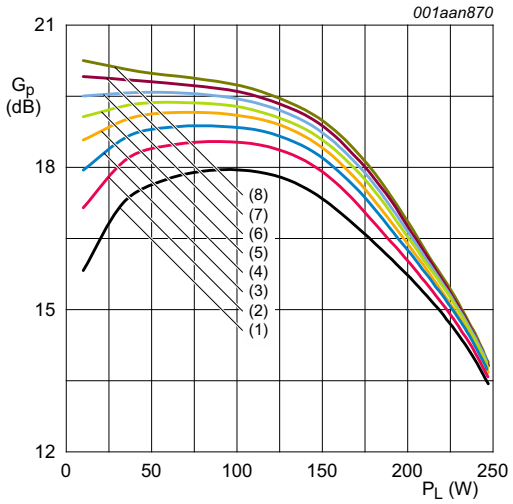
Fig 3. Power gain and drain efficiency as function of output power; typical values

7.4.2 2-Carrier CW



V_{DS} = 50 V; I_{Dq} = 100 mA; carrier spacing = 100 kHz.

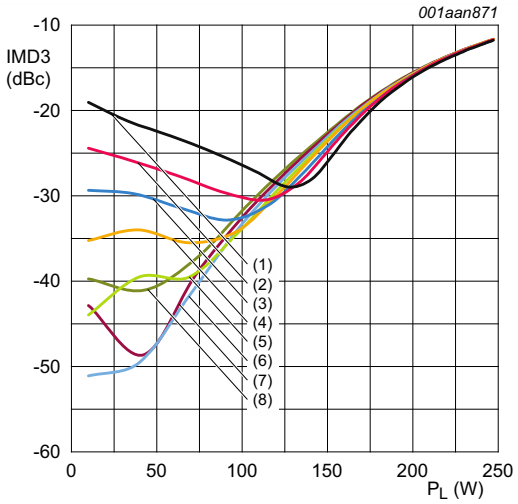
Fig 4. Power gain and drain efficiency as function of output power; typical values



V_{DS} = 50 V; f = 1300 MHz; carrier spacing = 100 kHz.

(1) I_{Dq} = 100 mA
(2) I_{Dq} = 300 mA
(3) I_{Dq} = 500 mA
(4) I_{Dq} = 700 mA
(5) I_{Dq} = 900 mA
(6) I_{Dq} = 1100 mA
(7) I_{Dq} = 1300 mA
(8) I_{Dq} = 1500 mA

Fig 5. Power gain as a function of output power; typical values



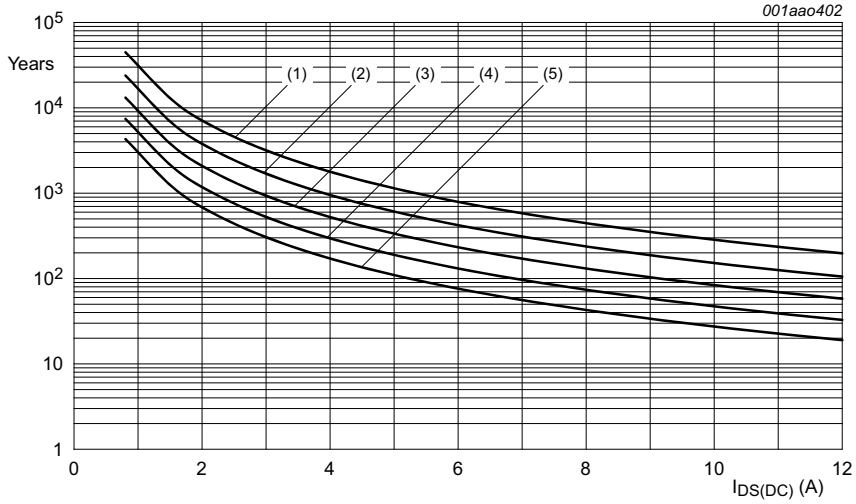
V_{DS} = 50 V; f = 1300 MHz; carrier spacing = 100 kHz.

(1) I_{Dq} = 100 mA
(2) I_{Dq} = 300 mA
(3) I_{Dq} = 500 mA
(4) I_{Dq} = 700 mA
(5) I_{Dq} = 900 mA
(6) I_{Dq} = 1100 mA
(7) I_{Dq} = 1300 mA
(8) I_{Dq} = 1500 mA

Fig 6. Third order intermodulation distortion as a function of output power; typical values

8. Test information

8.1 Reliability



MTTF (Years)

The reliability at pulsed conditions can be calculated as follows: MTTF x 1 / δ.

(1) T_j = 130 °C

(2) T_j = 140 °C

(3) T_j = 150 °C

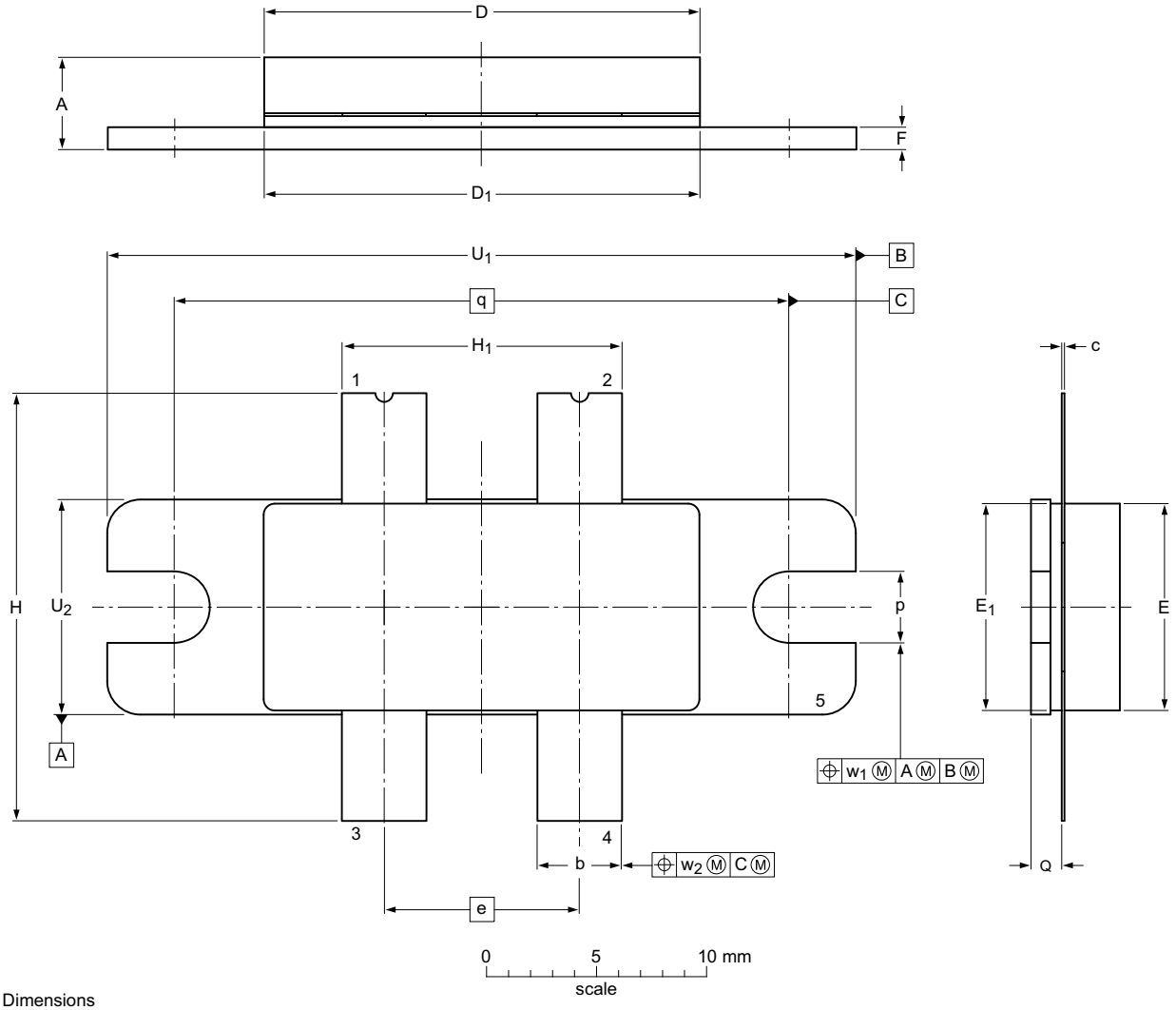
(4) T_j = 160 °C

(5) T_j = 170 °C

Fig 7. Electromigration ($I_{DS(DC)}$, total device)

9. Package outline

Flanged LDMOST ceramic package; 2 mounting holes; 4 leads **SOT1121A**



Dimensions

Unit[1]		A	b	c	D	D1	e	E	E1	F	H	H1	p	Q[2]	q	U1	U2	w1	w2
mm	max	4.75	3.94	0.18	20.02	19.96		9.53	9.53	1.14	19.94	12.83	3.38	1.70		34.16	9.91		
	nom						8.89								27.94			0.25	0.51
	min	3.45	3.68	0.10	19.61	19.66		9.27	9.27	0.89	18.92	12.57	3.12	1.45		33.91	9.65		
inches	max	0.187	0.155	0.007	0.788	0.786		0.375	0.375	0.045	0.785	0.505	0.133	0.067		1.345	0.39		
	nom						0.35								1.1			0.01	0.02
	min	0.136	0.145	0.004	0.772	0.774		0.365	0.365	0.035	0.745	0.495	0.123	0.057		1.335	0.38		

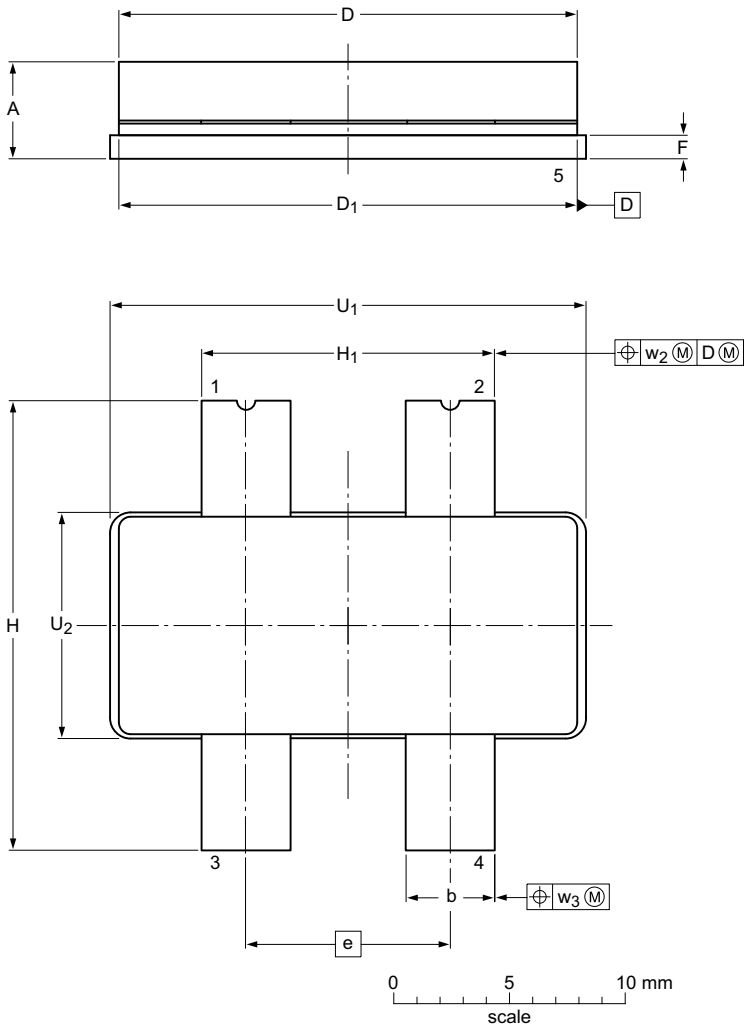
Note
1. millimeter dimensions are derived from the original inch dimensions.
2. dimension is measured 0.030 inch (0.76 mm) from the body.

sot1121a_po

Outline version	References				European projection	Issue date
	IEC	JEDEC	JEITA			
SOT1121A						~~09-10-12~~ 10-02-02

Fig 8. Package outline SOT1121A

Earless flanged ceramic package; 4 leads **SOT1121B**



Dimensions

Unit[1]		A	b	c	D	D_1	e	E	E_1	F	H	H_1	Q	U_1	U_2	w_2	w_3	y
mm	max	4.75	3.94	0.18	20.02	19.96		9.53	9.53	1.14	19.94	12.83	1.70	20.70	9.91	0.51	0.25	0.10
	nom						8.89											
	min	3.45	3.68	0.08	19.61	19.66		9.27	9.27	0.89	18.92	12.57	1.45	20.45	9.65			
inches	max	0.187	0.155	0.007	0.788	0.786		0.375	0.375	0.045	0.785	0.505	0.067	0.815	0.39	0.02	0.01	0.004
	nom						0.35											
	min	0.136	0.145	0.003	0.772	0.774		0.365	0.365	0.035	0.745	0.495	0.057	0.805	0.38			

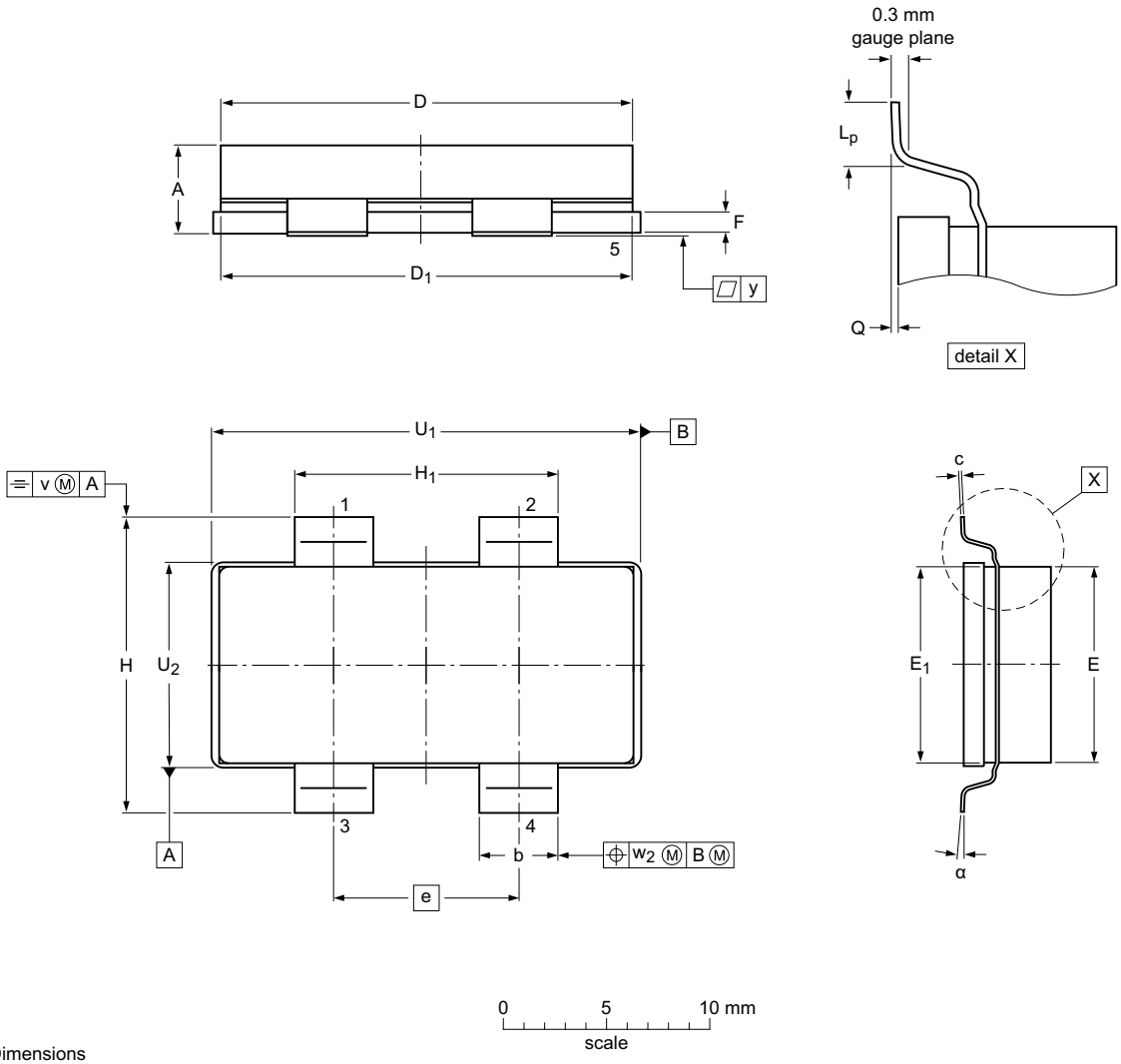
Note
1. millimeter dimensions are derived from the original inch dimensions.
2. dimension is measured 0.030 inch (0.76 mm) from the body.

sot1121b_po

Outline version	References				European projection	Issue date
	IEC	JEDEC	JEITA			
SOT1121B						~~12-06-07~~ 15-07-21

Fig 9. Package outline SOT1121B

Earless flanged LDMOST ceramic package; 4 leads **SOT1121E**



Dimensions

Unit[1]		A	b	c	D	D_1	e	E	E_1	F	H	H_1	L_p	Q	U_1	U_2	v	w_2	y	α
mm	max	4.75	3.94	0.18	20.02	19.96		9.53	9.53	1.14	14.3	12.83	1.38	0.050	20.70	9.91	0.25	0.25	0.10	7°
	nom						8.89													
	min	3.45	3.68	0.08	19.61	19.66		9.27	9.27	0.89	14.1	12.57	0.98	-0.050	20.45	9.65				0°
inches	max	0.187	0.155	0.007	0.788	0.786		0.375	0.375	0.045	0.563	0.505	0.055	-0.002	0.815	0.39	0.01	0.01	0.004	7°
	nom						0.35													
	min	0.136	0.145	0.003	0.772	0.774		0.365	0.365	0.035	0.555	0.495	0.039	-0.002	0.805	0.38				0°

Note
1. Millimeter dimensions are derived from the original inch dimensions.

sot1121e_po

Outline version	References				European projection	Issue date
	IEC	JEDEC	JEITA			
SOT1121E						~~14-06-12~~ 14-06-23

Fig 10. Package outline SOT1121E

10. Handling information

CAUTION	
	This device is sensitive to ElectroStatic Discharge (ESD). Observe precautions for handling electrostatic sensitive devices. Such precautions are described in the *ANSI/ESD S20.20*, *IEC/ST 61340-5*, *JESD625-A* or equivalent standards.

11. Abbreviations

Table 10. Abbreviations

Acronym	Description
CW	Continuous Wave
ESD	ElectroStatic Discharge
LDMOS	Laterally Diffused Metal-Oxide Semiconductor
LDMOST	Laterally Diffused Metal-Oxide Semiconductor Transistor
MTF	Median Time to Failure
MTTF	Mean Time to Failure
SMD	Surface-Mounted Device
VSWR	Voltage Standing-Wave Ratio

12. Revision history

Table 11. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
BLF6G13L-250P_LS-250P_LS-250PG#5	20150901	Product data sheet	-	BLF6G13L-250P_6G13LS-250P v.4
Modifications:	• The format of this document has been redesigned to comply with the new identity guidelines of Ampleon. • Legal texts have been adapted to the new company name where appropriate.			
BLF6G13L-250P_LS-250P_LS-250PG v.4	<tbd>	Product data sheet	-	BLF6G13L-250P_6G13LS-250P v.3
BLF6G13L-250P_6G13LS-250P v.3	20111014	Product data sheet	-	BLF6G13L-250P_6G13LS-250P v.2
BLF6G13L-250P_6G13LS-250P v.2	20110321	Objective data sheet	-	BLF6G13L-250P_6G13LS-250P v.1
BLF6G13L-250P_6G13LS-250P v.1	20101102	Objective data sheet	-	-

13. Legal information

13.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.ampleon.com.

13.2 Definitions

Draft — The document is a draft version only. The content is still under internal review and subject to formal approval, which may result in modifications or additions. Ampleon does not give any representations or warranties as to the accuracy or completeness of information included herein and shall have no liability for the consequences of use of such information.

Short data sheet — A short data sheet is an extract from a full data sheet with the same product type number(s) and title. A short data sheet is intended for quick reference only and should not be relied upon to contain detailed and full information. For detailed and full information see the relevant full data sheet, which is available on request via the local Ampleon sales office. In case of any inconsistency or conflict with the short data sheet, the full data sheet shall prevail.

Product specification — The information and data provided in a Product data sheet shall define the specification of the product as agreed between Ampleon and its customer, unless Ampleon and customer have explicitly agreed otherwise in writing. In no event however, shall an agreement be valid in which the Ampleon product is deemed to offer functions and qualities beyond those described in the Product data sheet.

13.3 Disclaimers

Limited warranty and liability — Information in this document is believed to be accurate and reliable. However, Ampleon does not give any representations or warranties, expressed or implied, as to the accuracy or completeness of such information and shall have no liability for the consequences of use of such information. Ampleon takes no responsibility for the content in this document if provided by an information source outside of Ampleon.

In no event shall Ampleon be liable for any indirect, incidental, punitive, special or consequential damages (including - without limitation - lost profits, lost savings, business interruption, costs related to the removal or replacement of any products or rework charges) whether or not such damages are based on tort (including negligence), warranty, breach of contract or any other legal theory.

Notwithstanding any damages that customer might incur for any reason whatsoever, Ampleon' aggregate and cumulative liability towards customer for the products described herein shall be limited in accordance with the *Terms and conditions of commercial sale* of Ampleon.

Right to make changes — Ampleon reserves the right to make changes to information published in this document, including without limitation specifications and product descriptions, at any time and without notice. This document supersedes and replaces all information supplied prior to the publication hereof.

Suitability for use — Ampleon products are not designed, authorized or warranted to be suitable for use in life support, life-critical or safety-critical systems or equipment, nor in applications where failure or malfunction of an Ampleon product can reasonably be expected to result in personal injury, death or severe property or environmental damage. Ampleon and its suppliers accept no liability for inclusion and/or use of Ampleon products in such equipment or applications and therefore such inclusion and/or use is at the customer's own risk.

Applications — Applications that are described herein for any of these products are for illustrative purposes only. Ampleon makes no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

Customers are responsible for the design and operation of their applications and products using Ampleon products, and Ampleon accepts no liability for any assistance with applications or customer product design. It is customer's sole responsibility to determine whether the Ampleon product is suitable and fit for the customer's applications and products planned, as well as for the planned application and use of customer's third party customer(s). Customers should provide appropriate design and operating safeguards to minimize the risks associated with their applications and products.

Ampleon does not accept any liability related to any default, damage, costs or problem which is based on any weakness or default in the customer's applications or products, or the application or use by customer's third party customer(s). Customer is responsible for doing all necessary testing for the customer's applications and products using Ampleon products in order to avoid a default of the applications and the products or of the application or use by customer's third party customer(s). Ampleon does not accept any liability in this respect.

Limiting values — Stress above one or more limiting values (as defined in the Absolute Maximum Ratings System of IEC 60134) will cause permanent damage to the device. Limiting values are stress ratings only and (proper) operation of the device at these or any other conditions above those given in the Recommended operating conditions section (if present) or the Characteristics sections of this document is not warranted. Constant or repeated exposure to limiting values will permanently and irreversibly affect the quality and reliability of the device.

Terms and conditions of commercial sale — Ampleon products are sold subject to the general terms and conditions of commercial sale, as published at http://www.ampleon.com/terms, unless otherwise agreed in a valid written individual agreement. In case an individual agreement is concluded only the terms and conditions of the respective agreement shall apply. Ampleon hereby expressly objects to applying the customer's general terms and conditions with regard to the purchase of Ampleon products by customer.

No offer to sell or license — Nothing in this document may be interpreted or construed as an offer to sell products that is open for acceptance or the grant, conveyance or implication of any license under any copyrights, patents or other industrial or intellectual property rights.

Export control — This document as well as the item(s) described herein may be subject to export control regulations. Export might require a prior authorization from competent authorities.

Non-automotive qualified products — Unless this data sheet expressly states that this specific Ampleon product is automotive qualified, the product is not suitable for automotive use. It is neither qualified nor tested in accordance with automotive testing or application requirements. Ampleon accepts no liability for inclusion and/or use of non-automotive qualified products in automotive equipment or applications.

In the event that customer uses the product for design-in and use in automotive applications to automotive specifications and standards, customer (a) shall use the product without Ampleon' warranty of the product for such automotive applications, use and specifications, and (b) whenever customer uses the product for automotive applications beyond Ampleon' specifications such use shall be solely at customer's own risk, and (c) customer fully indemnifies Ampleon for any liability, damages or failed product claims resulting from customer design and use of the product for automotive applications beyond Ampleon' standard warranty and Ampleon' product specifications.

Translations — A non-English (translated) version of a document is for reference only. The English version shall prevail in case of any discrepancy between the translated and English versions.

13.4 Trademarks

Notice: All referenced brands, product names, service names and trademarks are the property of their respective owners.

Any reference or use of any 'NXP' trademark in this document or in or on the surface of Ampleon products does not result in any claim, liability or entitlement vis-à-vis the owner of this trademark. Ampleon is no longer part of the NXP group of companies and any reference to or use of the 'NXP' trademarks will be replaced by reference to or use of Ampleon's own Any reference or use of any 'NXP' trademark in this document or in or on the surface of Ampleon products does not result in any claim, liability or entitlement vis-à-vis the owner of this trademark. Ampleon is no longer part of the NXP group of companies and any reference to or use of the 'NXP' trademarks will be replaced by reference to or use of Ampleon's own trademarks.

14. Contact information

For more information, please visit:
http://www.ampleon.com

For sales office addresses, please visit:
http://www.ampleon.com/sales

15. Contents

1 Product profile 1
1.1 General description 1
1.2 Features and benefits 1
1.3 Applications 1
2 Pinning information 2
3 Ordering information 2
4 Limiting values 3
5 Thermal characteristics 3
6 Characteristics 3
7 Application information 4
7.1 Ruggedness in class-AB operation 4
7.2 Impedance information 4
7.3 Circuit information 4
7.4 Graphical data 6
7.4.1 CW 6
7.4.2 2-Carrier CW 6
8 Test information 8
8.1 Reliability 8
9 Package outline 9
10 Handling information 12
11 Abbreviations 12
12 Revision history 12
13 Legal information 13
13.1 Data sheet status 13
13.2 Definitions 13
13.3 Disclaimers 13
13.4 Trademarks 14
14 Contact information 14
15 Contents 15

For more information, please visit: http://www.ampleon.com
For sales office addresses, please visit: http://www.ampleon.com/sales

Date of release: 1 September 2015
Document identifier: BLF6G13L-250P_LS-250P_LS-250PG#5